

## **STDF FACILITY**

<b>SI No.</b>	<b>Equipment</b>
1	F&S Wire Bonder
2	Mask Aligner
3	Spin Coater + Hot Plate
4	Wet bench + hot plate
5	Plasma Cleaner
6	Bond Tester
7	Wafer Dicer
8	Probe Station + Impedance Analyzer
9	Optical microscope
10	Critical Point Dryer

## **SVT LAB SERVICES LIST**

<b>SI. No.</b>	<b>Equipment</b>
1	Wire bonder
2	Bond tester
3	Optical Microscope
4	Mask Aligner
5	Mask writer
6	Wet bench + Spin coater + Hot plate
7	Wet + Hot plate
8	Flip Chip Bonder
9	Wet bench + Hot plate
10	Electroplating System
11	Hot Embossing
12	UV Nano Imprint Lithography
13	Wafer Bonder
14	Wafer Dicer
15	Critical Point Dryer
16	Plasma Cleaner
17	Probe Station + Impedance Analyzer
18	X Ray Inspection System
19	Electron Beam Welding
20	Seam Sealer
21	Helium Leak Detector
22	Helium Leak Detector Chambers
23	Electron beam Evaporation